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Texas Instruments Incorporated
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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re the Application of
Morio Nakao

Docket Number: TI-35373

Serial No.: 10/631,083

Art Unit: 2822

Filed: 07/31/03

Examiner: David E. Graybill

For: HIGH RELIABILITY CHIP SCALE PACKAGE

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NAME OF INVENTOR(S): MORIO NAKAO	
TITLE OF INVENTION: HIGH RELIABILITY CHIP SCALE PACKAGE	
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Texas Instruments Incorporated
PO Box 655474, M/S 3999
Dallas, TX 75265